

Features

- Low V_F schottky barrier rectifiers
- Low profile - typical height 1.0 mm
- Low forward voltage drop
- Low leakage current
- Moisture sensitivity: level 1, per J-STD-020



Package: eSGA
 (SOD-123FL)

Applications

For use in fast switching in RF module, lighting, cell phone, portable devices, power supply and other consumer applications.

Maximum Ratings ($T_A = 25^\circ\text{C}$ unless otherwise noted)

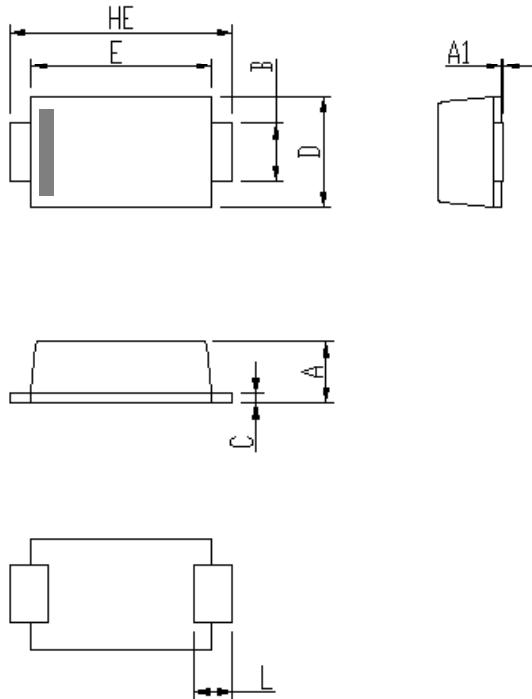
Parameter	Symbol	FS22N	FS22NS	FSL23	FSL23S	FSL24	FS24N	FSL26	Unit
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	20	20	30	30	40	40	60	V
Maximum RMS Voltage	V_{RMS}	14	14	21	21	28	28	42	V
Maximum DC Blocking Voltage	V_{DC}	20	20	30	30	40	40	60	V
Maximum Average Forward Rectified Current	$I_{F(AV)}$					2.0			A
Peak Forward Surge Current (8.3 ms single half sine-wave superimposed on rated load)	I_{FSM}			50		80		50	A
Operating Junction and Storage Temperature Range	T_J, T_{STG}			- 55 to + 150					$^\circ\text{C}$

Electrical Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Test Conditions	Symbol	FS22N	FS22NS	FSL23	FSL23S	FSL24	FS24N	FSL26	Unit
Maximum Instantaneous Forward Voltage	2 A	V_F	0.43	0.45	0.5	0.43	0.43	0.45	0.50	V
Maximum DC Reverse Current @Rated DC Blocking Voltage	$T_A=25^\circ\text{C}$	I_R	0.5	0.5	0.5	0.5	1	1	1	mA
Typical Thermal Resistance	Junction to Lead	$R_{\theta JL}$				20				$^\circ\text{C/W}$

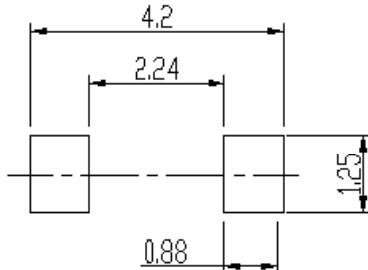
Package Outline Dimensions

eSGA (SOD-123FL)



DIM	Unit: mm		Unit: inch	
	MIN	MAX	MIN	MAX
A	0.9	1.08	0.035	0.043
A1	0	0.1	0.000	0.004
B	0.85	1.05	0.033	0.041
C	0.1	0.25	0.004	0.010
D	1.7	2	0.067	0.079
E	2.9	3.1	0.114	0.122
L	0.43	0.83	0.017	0.033
HE	3.5	3.9	0.138	0.154

Soldering footprint



Packing Information

Packing quantities

3000 pcs/Reel, 40 Reels/Box; 8mm Tape, 7" Reel

Tape & Reel Spec

